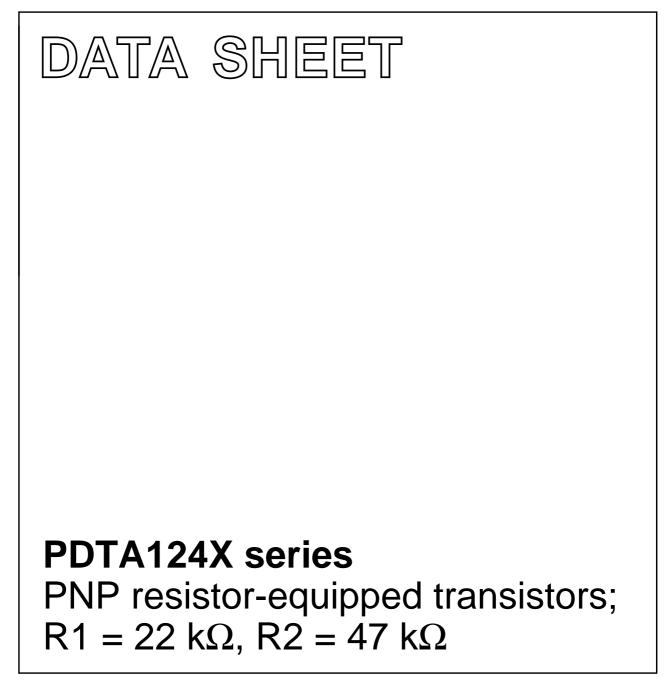
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2004 Apr 07 2004 Aug 04



PDTA124X series

FEATURES

- Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit driver.

PRODUCT OVERVIEW

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	-50	V
lo	output current (DC)	-	-100	mA
R1	bias resistor	22	_	kΩ
R2	bias resistor	47	_	kΩ

DESCRIPTION

PNP resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

TYPE NUMBER	PACKAGE		MARKING CODE	NPN COMPLEMENT	
	PHILIPS	EIAJ			
PDTA124XE	SOT416	SC-75	31	PDTC124XE	
PDTA124XEF	SOT490	SC-89	31	PDTC124XEF	
PDTA124XK	SOT346	SC-59	44	PDTC124XK	
PDTA124XM	SOT883	SC-101	DK	PDTC124XM	
PDTA124XS	SOT54 (TO-92)	SC-43	TA124X	PDTC124XS	
PDTA124XT	SOT23	_	*47 ⁽¹⁾	PDTC124XT	
PDTA124XU	SOT323	SC-70	*44(1)	PDTC124XU	

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

PDTA124X series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

	SIMPLIFIED OUTLINE AND SYMBOL		PINNING		
TYPE NUMBER			DESCRIPTION		
PDTA124XS		1 2 3	base collector emitter		
PDTA124XE		1	base		
PDTA124XEF		2	emitter		
PDTA124XK PDTA124XT PDTA124XU	3 1 3 1 2 Top view MDB271	3	collector		
PDTA124XM		1	base		
		2	emitter		
	2 1 Bottom view Bottom view MDB267	3	collector		

PDTA124X series

ORDERING INFORMATION

		PACKAGE			
TYPE NUMBER	NAME	DESCRIPTION	VERSION		
PDTA124XE	 plastic surface mounted package; 3 leads 		SOT416		
PDTA124XEF	_	 plastic surface mounted package; 3 leads SOT 			
PDTA124XK	_	- plastic surface mounted package; 3 leads SOT3			
PDTA124XM	_	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5$ mm			
PDTA124XS	 plastic single-ended leaded (through hole) package; 3 leads 		SOT54		
PDTA124XT	 plastic surface mounted package; 3 leads SOT 		SOT23		
PDTA124XU	_	 plastic surface mounted package; 3 leads SOT3 			

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
V _{CBO}	collector-base voltage	open emitter	_	-50	V	
V _{CEO}	collector-emitter voltage	open base	-	-50	V	
V _{EBO}	emitter-base voltage	open collector	-	-10	V	
VI	input voltage					
	positive		_	+10	V	
	negative		-	-40	V	
lo	output current (DC)		_	-100	mA	
I _{CM}	peak collector current		_	-100	mA	
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C				
	SOT54	note 1	_	500	mW	
	SOT23	note 1	_	250	mW	
	SOT346	note 1	_	250	mW	
	SOT323	note 1	_	200	mW	
	SOT416	note 1	_	150	mW	
	SOT490	notes 1 and 2	_	250	mW	
	SOT883	notes 2 and 3	_	250	mW	
T _{stg}	storage temperature		-65	+150	°C	
Tj	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

PDTA124X series

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

CHARACTERISTICS

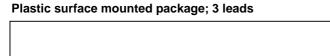
 T_{amb} = 25 °C unless otherwise specified.

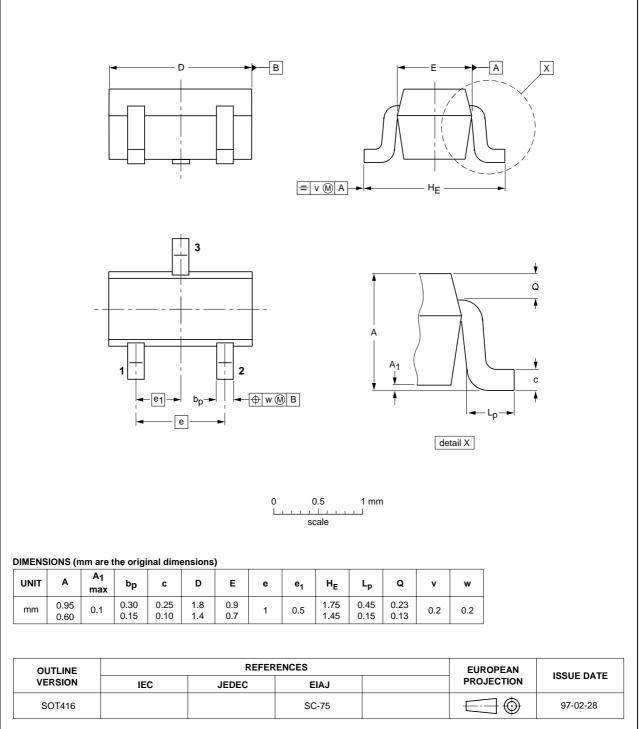
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0 \text{ A}$	-	-	-100	nA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; I_B = 0 \text{ A}$	-	-	-1	μA
		$V_{CE} = -30 \text{ V}; I_B = 0; T_j = 150 \text{ °C}$	-	-	-50	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	-120	μA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V}; \text{ I}_{C} = -5 \text{ mA}$	80	-	-	
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = -10 \text{ mA}; I_{B} = -0.5 \text{ mA}$	-	-	-150	mV
V _{i(off)}	input-off voltage	$I_{C} = -100 \ \mu A; V_{CE} = -5 \ V$	-	-0.8	-0.5	V
V _{i(on)}	input-on voltage	$I_{C} = -2 \text{ mA}; V_{CE} = -0.3 \text{ V}$	-2	-1.1	-	V
R1	input resistor		15.4	22	28.6	kΩ
R2 R1	resistor ratio		1.7	2.1	2.6	
C _c	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = -10 \text{ V};$ f = 1 MHz	_	-	3	pF

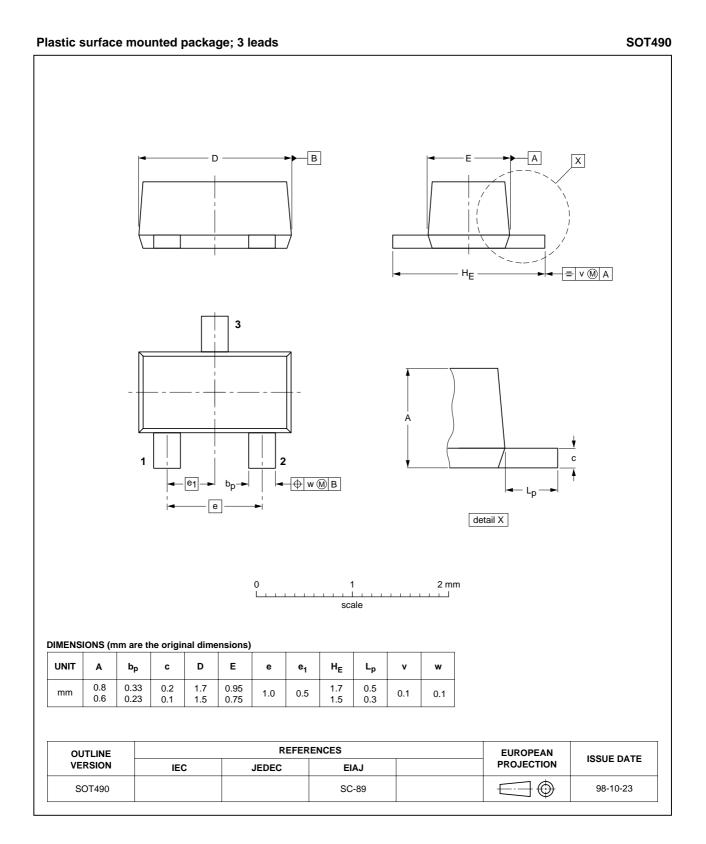
PDTA124X series

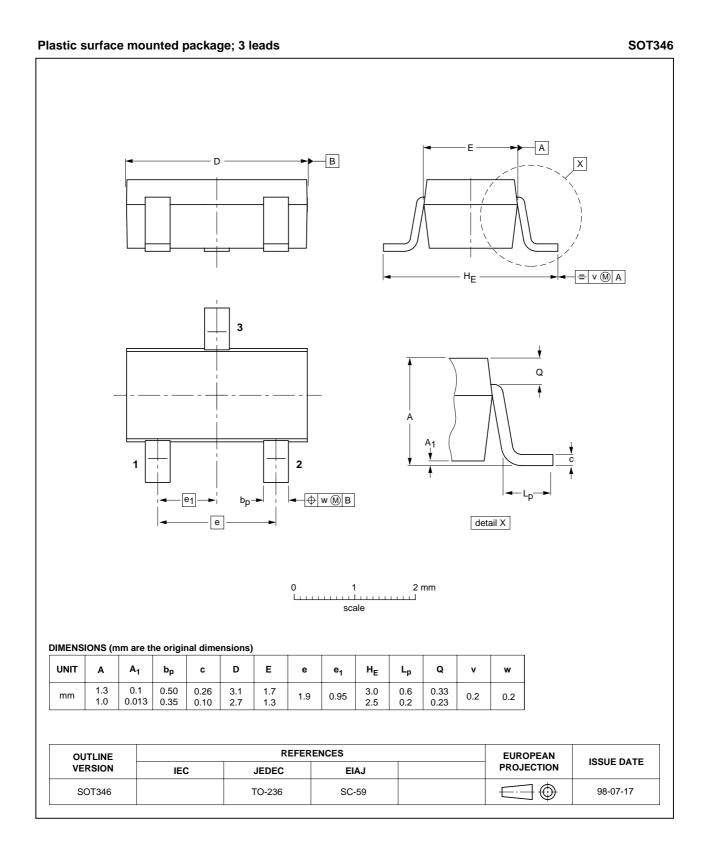
PNP resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

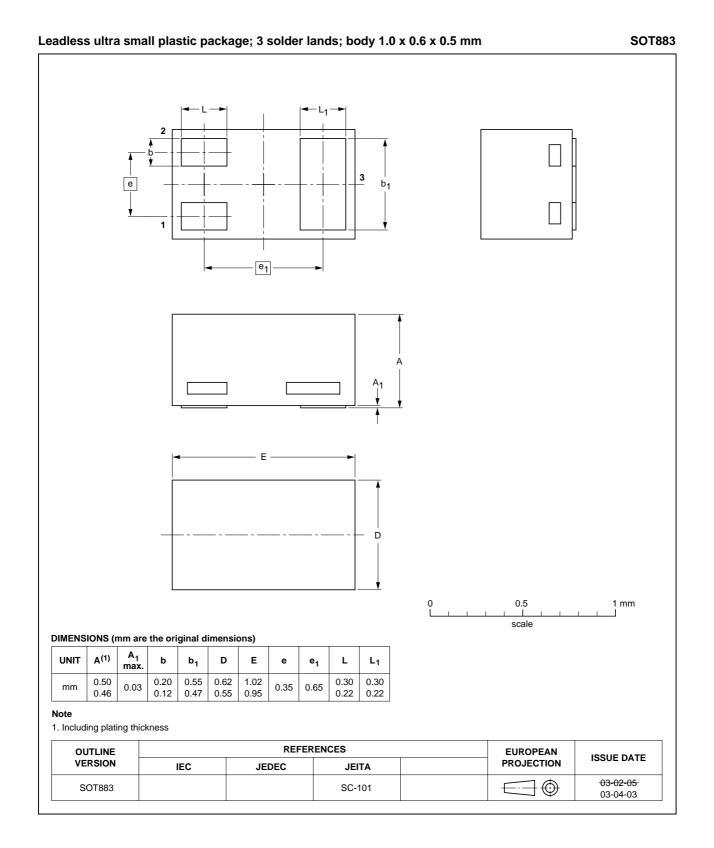
PACKAGE OUTLINES

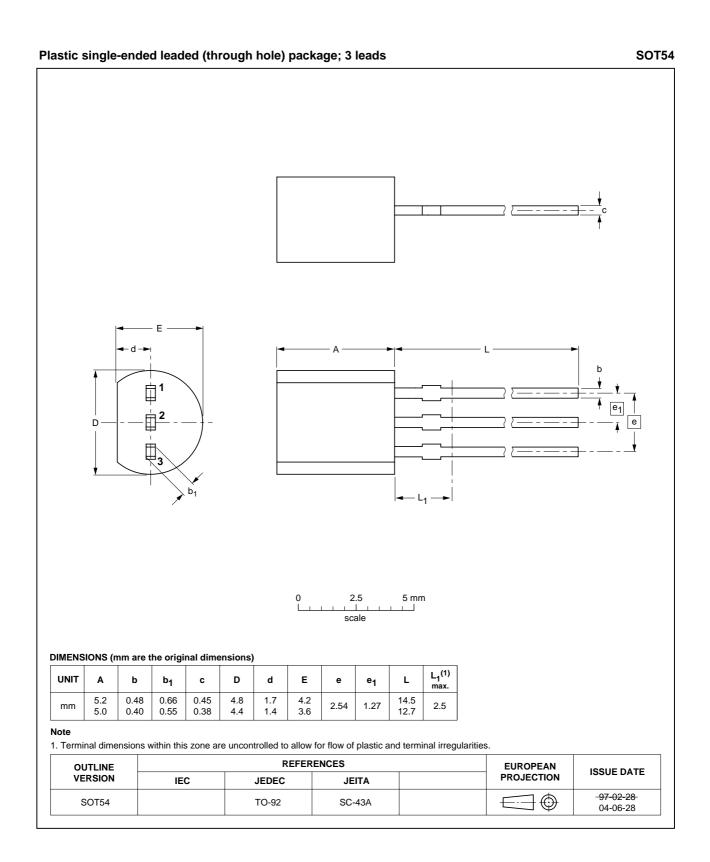


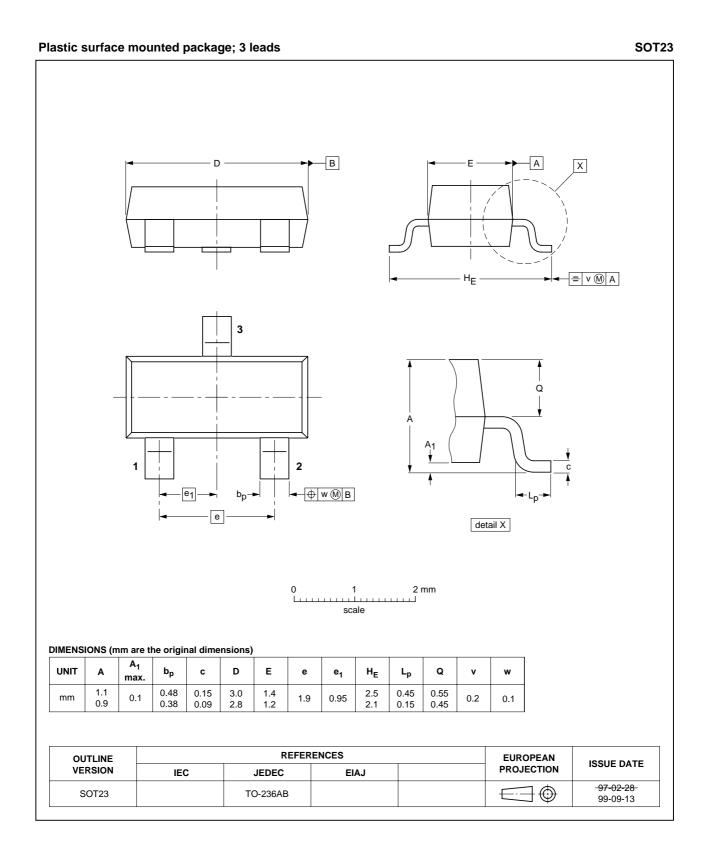


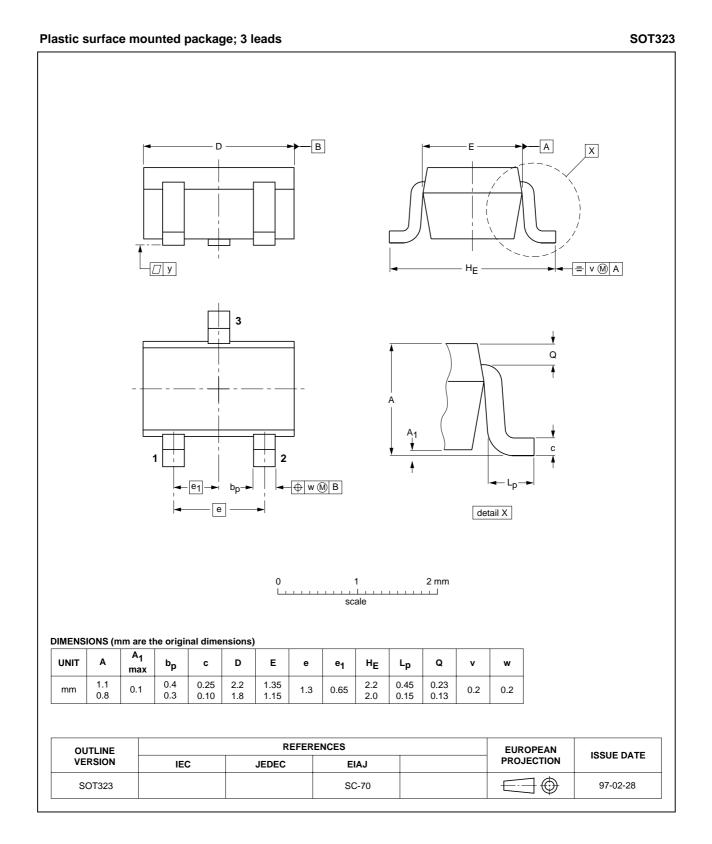












PDTA124X series

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
11	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R75/06/pp14

Date of release: 2004 Aug 04

Document order number: 9397 750 13654

SCA76

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